

Microelectronics Circuit Analysis and Design

Donald A. Neamen

Chapter 3

The Field Effect Transistor

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Chapter 3-1

In this chapter, we will:

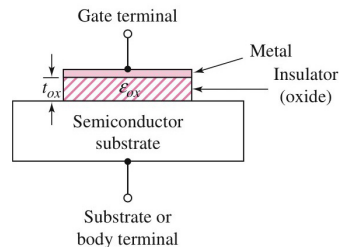
- Study and understand the operation and characteristics of the various types of MOSFETs.
- Understand and become familiar with the dc analysis and design techniques of MOSFET circuits.
- Examine three applications of MOSFET circuits.
- Investigate current source biasing of MOSFET circuits, such as those used in integrated circuits.

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Chapter 3-2

Basic Structure of MOS Capacitor



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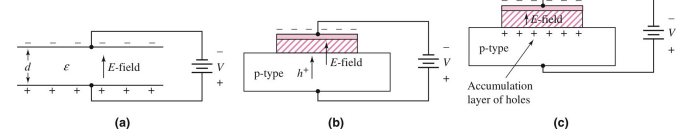
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MOS Capacitor Under Bias: Electric Field and Charge

Parallel plate capacitor



Negative gate bias:

Holes attracted to gate

Positive gate bias:

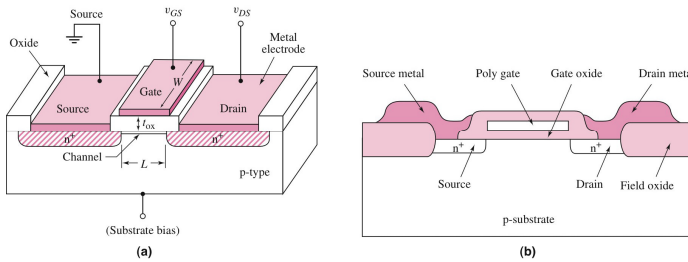
Electrons attracted to gate

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Schematic of n-Channel Enhancement Mode MOSFET

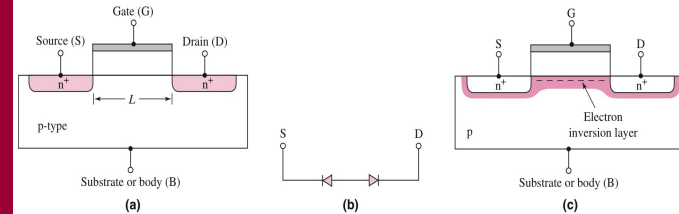


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Basic Transistor Operation

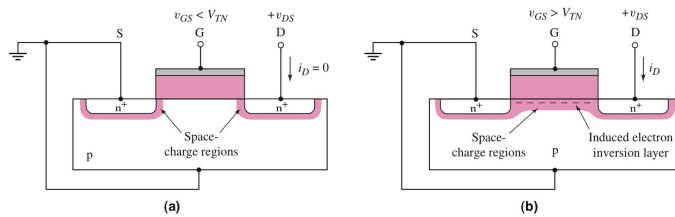
Before electron
inversion layer is
formedAfter electron
inversion layer is
formed

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Basic Transistor Operation

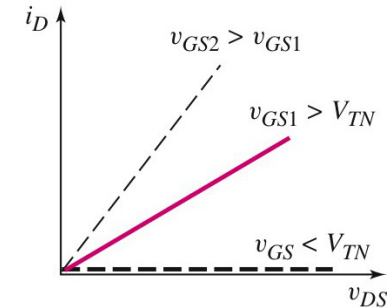


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Current Versus Voltage Characteristics: Enhancement-Mode nMOSFET

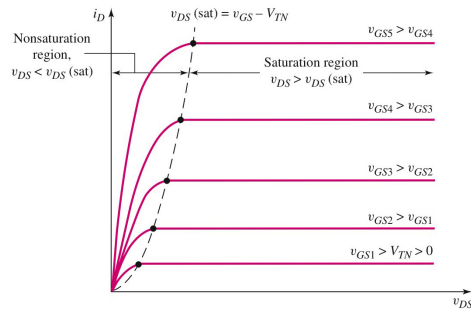


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Family of i_D Versus v_{DS} Curves: Enhancement-Mode nMOSFET

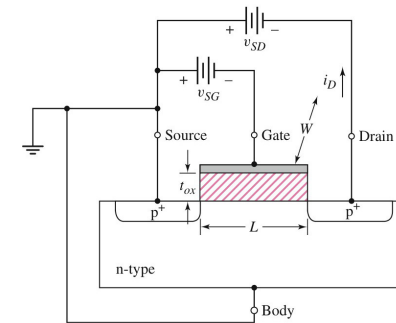


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p-Channel Enhancement-Mode MOSFET

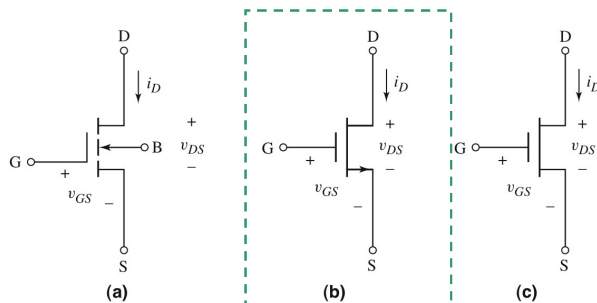


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Symbols for n-Channel Enhancement-Mode MOSFET

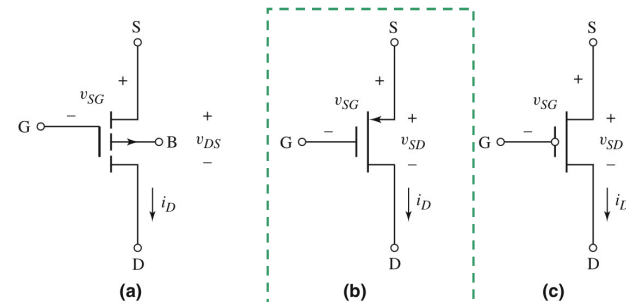


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Symbols for p-Channel Enhancement-Mode MOSFET

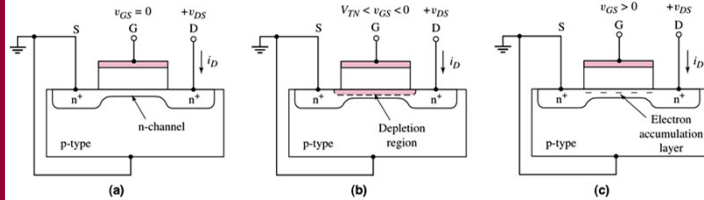


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n-Channel Depletion-Mode MOSFET

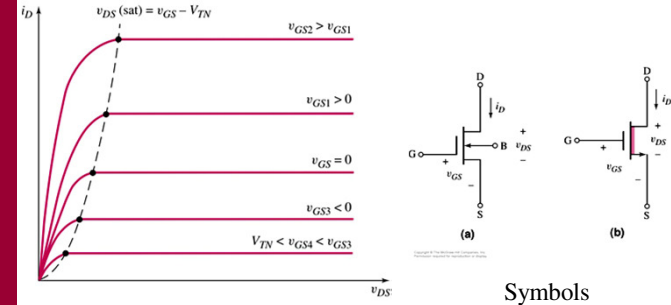


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Family of i_D Versus v_{DS} Curves: Depletion-Mode nMOSFET

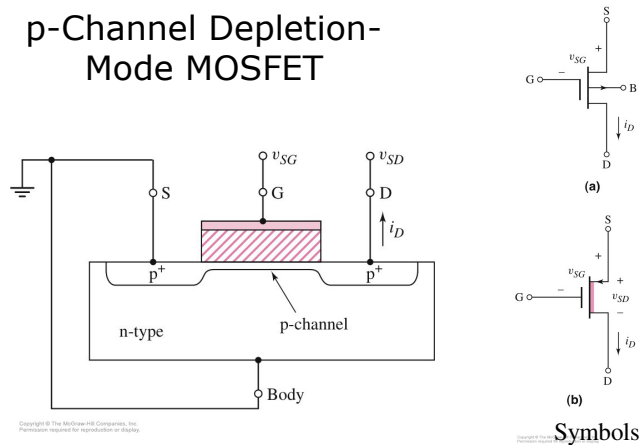


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p-Channel Depletion-Mode MOSFET

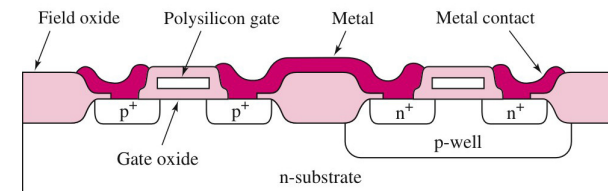


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Cross-Section of nMOSFET and pMOSFET



Both transistors are used in the fabrication of CMOS circuitry.

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Summary of I-V Relationships

| Region | NMOS | PMOS |
|------------------|--|--|
| Nonsaturation | $v_{DS} < v_{DS}(\text{sat})$ $i_D = K_n [2(v_{GS} - V_{TN})v_{DS} - v_{DS}^2]$ | $v_{SD} < v_{SD}(\text{sat})$ $i_D = K_p [2(v_{SG} + V_{TP})v_{SD} - v_{SD}^2]$ |
| Saturation | $v_{DS} > v_{DS}(\text{sat})$ $i_D = K_n [v_{GS} - V_{TN}]^2$ | $v_{SD} > v_{SD}(\text{sat})$ $i_D = K_p [v_{SG} + V_{TP}]^2$ |
| Transition Pt. | $v_{DS}(\text{sat}) = v_{GS} - V_{TN}$ | $v_{SD}(\text{sat}) = v_{SG} + V_{TP}$ |
| Enhancement Mode | $V_{TN} > 0V$ | $V_{TP} < 0V$ |
| Depletion Mode | $V_{TN} < 0V$ | $V_{TP} > 0V$ |

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Conduction Parameters

□ NMOSFET

$$K_n = \frac{W\mu_n C_{ox}}{2L} = k'_n \frac{W}{2L}$$

□ PMOSFET

$$K_p = \frac{W\mu_p C_{ox}}{2L} = k'_p \frac{W}{2L}$$

where:

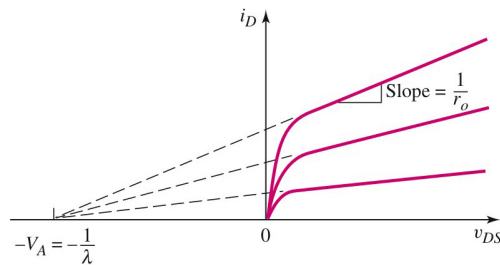
$$C_{ox} = \epsilon_o / t_{ox}$$

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Channel Length Modulation: Early Voltage

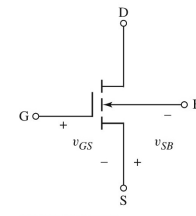
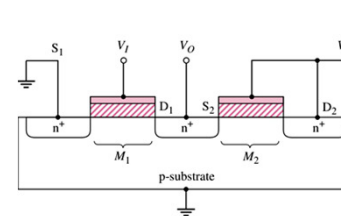
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Body Effect



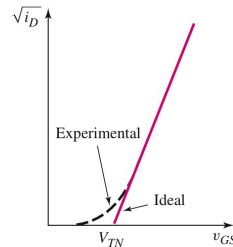
- Causes an increase in the required threshold voltage
- This is a small effect for a single device and will be ignored

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Subthreshold Condition



- Small current flows for voltages threshold voltage.
- This is a small effect for a single device and will be ignored.

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Problem-Solving Technique: NMOSFET DC Analysis

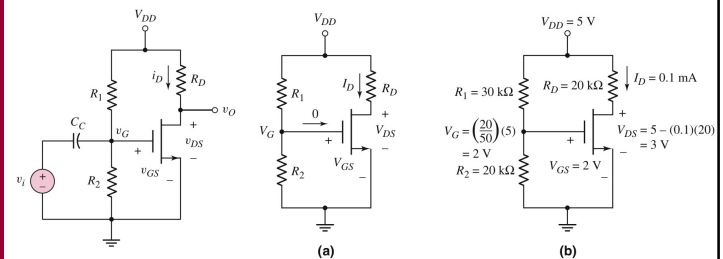
1. Assume the transistor is in saturation.
 - a. $V_{GS} > V_{TN}$, $I_D > 0$, & $V_{DS} \geq V_{DS}(\text{sat})$
2. Analyze circuit using saturation I-V relations.
3. Evaluate resulting bias condition of transistor.
 - a. If $V_{GS} < V_{TN}$, transistor is likely in cutoff
 - b. If $V_{DS} < V_{DS}(\text{sat})$, transistor is likely in nonsaturation region
4. If initial assumption is proven incorrect, make new assumption and repeat Steps 2 and 3.

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NMOS Common-Source Circuit



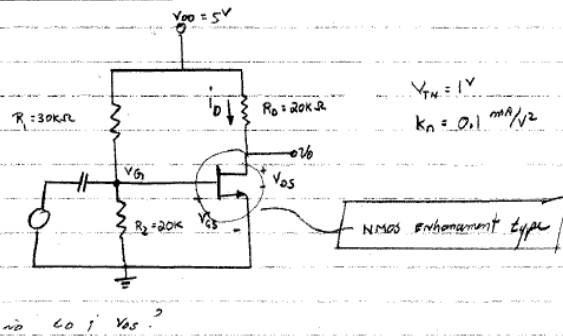
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II MOSFET DC ANALYSIS

A. Common-Source Circuit



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$$\textcircled{1} \quad V_G = V_{GS} = \left(\frac{R_2}{R_1 + R_2} \right) V_{DD} = \left(\frac{20}{20+30} \right) 5 = \textcircled{2V}$$

② Assuming transistor biased in SAT Region:

$$I_D = K_n (V_{GS} - V_{TN})^2 = (0.1)(2-1)^2 = 0.1 \text{ mA}$$

$$V_{DS} = V_{DD} - I_D R_D = 5 - (0.1)(20) = 3V$$

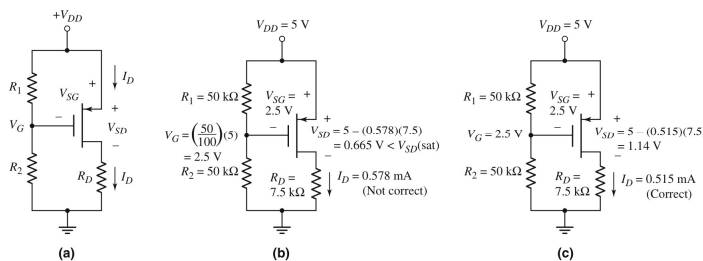
Since: $V_{DS} = 3V > V_{DS(sat)} = V_{GS} - V_{TN} = 2-1 = 1V$, the MOSFET IS INDEED BIASED IN SAT REGION.

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PMOS Common-Source Circuit

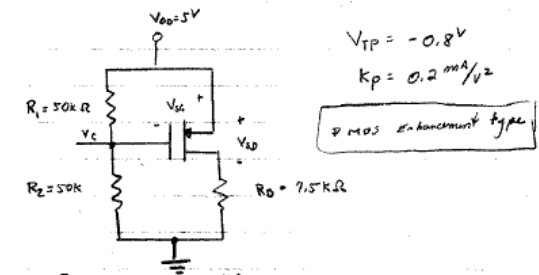


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Ex #2



$$V_G = 5 \left(\frac{R_2}{R_1 + R_2} \right) = 5 \left(\frac{50}{100} \right) = 2.5V$$

$$V_{SG} = V_{DD} - V_G = 5 - 2.5 = 2.5V$$

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... Assuming SAT: $I_D = K_p (V_{GS} + V_{TP})^2 = 0.2 \text{ mA} (2.5 - 0.8)^2$
 $= 0.578 \text{ mA}$
 ... then: $V_{SD} = V_{DD} - I_D R_D = 5 - (0.578 \text{ mA})(7.5 \text{ k}) = 0.665 \text{ V}$
 Note: $V_{SD} = 0.665 \text{ V} < V_{SD(SAT)} = V_{GS} + V_{TP} = 2.5 - 0.8 = 1.7 \text{ V}$
 ∴ NOT BIASED in SAT Region!

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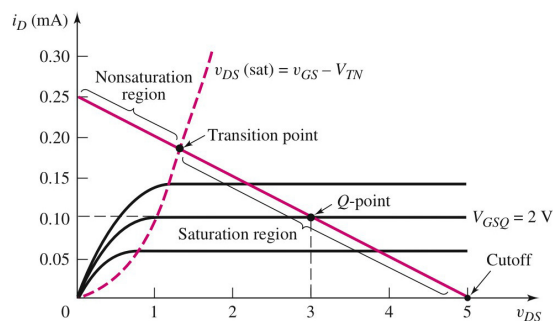
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$I_D = K_p [2(V_{GS} + V_{TP})V_{SD} - V_{SD}^2]$ ← Use Non Sat. EQN.
 $V_{SD} = V_{DD} - I_D R_D$
 $I_D = K_p [2(V_{GS} + V_{TP})(V_{DD} - I_D R_D) - (V_{DD} - I_D R_D)^2]$
 $I_D = 0.2 \text{ mA} [2(2.5 - 0.8)(5 - I_D(7.5 \text{ k})) - (5 - I_D(7.5 \text{ k}))^2]$
 $= 0.2 \text{ mA} [17 - I_D(25.5 \text{ k}) - (25 + I_D^2(56.25 \times 10^6) - (7.5 \text{ k})I_D)]$
 $5 \text{ k } I_D = I_D(7.5 \text{ k} - 25.5 \text{ k}) - I_D^2(56.25 \times 10^6) - 8$
 $56.25 \times 10^6 I_D^2 - 44.5 \text{ k } I_D = 8$
 $I_D = 0.515 \text{ mA} \text{ or } 0.276 \text{ mA}$
 ∴ $V_{SD} = 5 - (0.515)(7.5) = 1.14 \text{ V} < V_{SD(SAT)} = 1.7 \text{ V}$ ← correct solution
 note: $V_{SD} = 5 - (0.276)(7.5) = 2.93 \text{ V} > V_{SD(SAT)}$ ← Not correct solution

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Load Line and Modes of Operation: NMOS Common-Source Circuit



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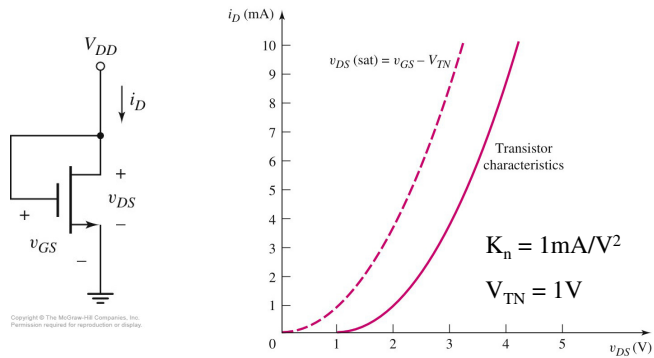
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Enhancement Load Device

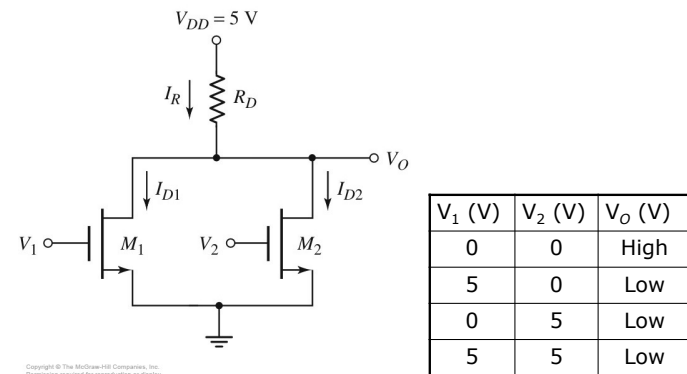


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2-Input NMOS NOR Logic Gate

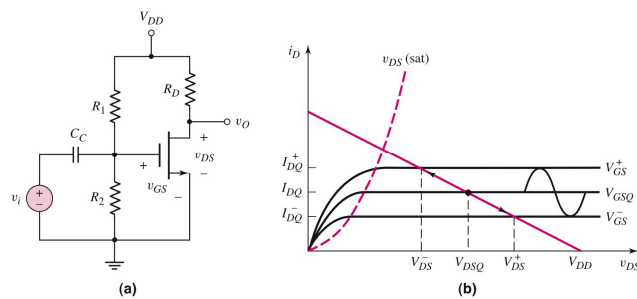


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MOS Small-Signal Amplifier

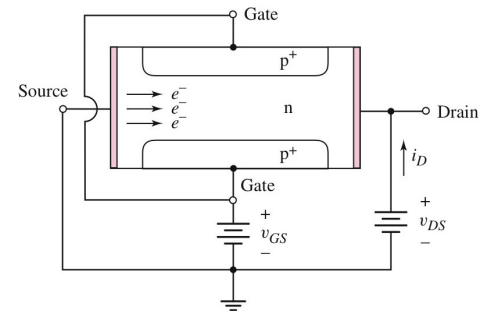


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Cross Section of n-Channel Junction Field Effect Transistor (JFET)



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